

(19) World Intellectual Property Organization  
International Bureau



(43) International Publication Date  
11 December 2008 (11.12.2008)

PCT

(10) International Publication Number  
**WO 2008/148866 A3**

(51) International Patent Classification:  
**H05K 13/02** (2006.01)

(21) International Application Number:  
PCT/EP2008/057046

(22) International Filing Date: 5 June 2008 (05.06.2008)

(25) Filing Language: English

(26) Publication Language: English

(30) Priority Data:  
07109833.9 7 June 2007 (07.06.2007) EP

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(81) Designated States (unless otherwise indicated, for every kind of national protection available): AE, AG, AL, AM, AO, AT, AU, AZ, BA, BB, BG, BH, BR, BW, BY, BZ, CA, CH, CN, CO, CR, CU, CZ, DE, DK, DM, DO, DZ, EC, EE, EG, ES, FI, GB, GD, GE, GH, GM, GT, HN, HR, HU, ID, IL, IN, IS, JP, KE, KG, KM, KN, KP, KR, KZ, LA, LC, LK, LR, LS, LT, LU, LY, MA, MD, ME, MG, MK, MN, MW, MX, MY, MZ, NA, NG, NI, NO, NZ, OM, PG, PH, PL, PT, RO, RS, RU, SC, SD, SE, SG, SK, SL, SM, SV, SY, TJ, TM, TN, TR, TT, TZ, UA, UG, US, UZ, VC, VN, ZA, ZM, ZW.

(84) Designated States (unless otherwise indicated, for every kind of regional protection available): ARIPO (BW, GH, GM, KE, LS, MW, MZ, NA, SD, SL, SZ, TZ, UG, ZM, ZW), Eurasian (AM, AZ, BY, KG, KZ, MD, RU, TJ, TM), European (AT, BE, BG, CH, CY, CZ, DE, DK, EE, ES, FI, FR, GB, GR, HR, HU, IE, IS, IT, LT, LU, LV, MC, MT, NL, NO, PL, PT, RO, SE, SI, SK, TR), OAPI (BF, BJ, CF, CG, CI, CM, GA, GN, GQ, GW, ML, MR, NE, SN, TD, TG).

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(54) Title: APPARATUS AND METHOD FOR SEPARATING ELECTRONIC COMPONENTS

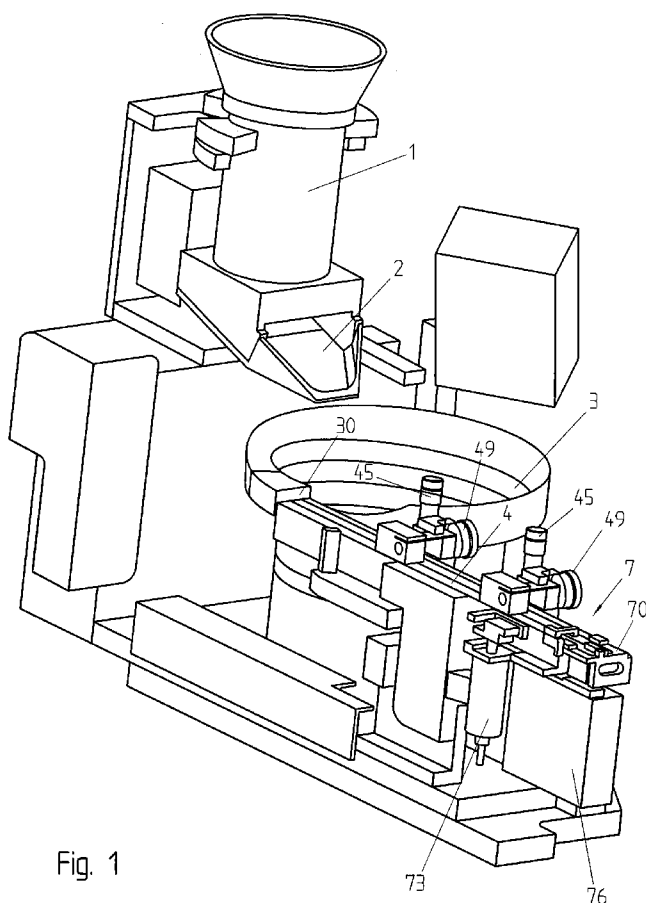


Fig. 1

(57) Abstract: An apparatus for isolating electronic components, comprising: a feeder track for moving a row of electronic components (6) to be isolated along a path, an abutment (71) at the end of said path, arranged for preventing displacement of the leading component in said row further than a predefined abutment position, a movable stop element (72, 74) at a fixed position along said path, for separating the leading component on one side of said stop element from all the components on the other side of said stop element, a carriage (70) for translating the electronic component (6) separated by said stop element (72, 74) at a predefined removal position where it can be gripped.

WO 2008/148866 A3



**Published:**

- *with international search report*
- *before the expiration of the time limit for amending the claims and to be republished in the event of receipt of amendments*

**(88) Date of publication of the international search report:**

5 February 2009